TinyLogic HST 2-Input Exclusive-OR Gate

NC7ST86

Description

The NC7ST86 is a single 2−Input high performance CMOS Exclusive−OR Gate, with TTL−compatible inputs. Advanced Silicon Gate CMOS fabrication assures high speed and low power circuit operation. ESD protection diodes inherently guard both inputs and outputs with respect to the V_{CC} and GND rails. High gain circuitry offers high noise immunity and reduced sensitivity to input edge rate. The TTL−compatible inputs facilitate TTL to NMOS / CMOS interfacing. Device performance is similar to MM74HCT but with $^1/_2$ the output current drive of HC / HCT.

Features

- Space Saving SOT23−5, SC−74A and SC−88A 5−Lead Package
- Ultra Small MicroPak™ Leadless Package
- High Speed: t_{PD} < 8 ns Typ, V_{CC} = 5 V, C_L = 15 pF
- Low Quiescent Power: I_{CC}< 1 µA Typ, V_{CC} = 5.5 V
- Balanced Output Drive: 2 mA I_{OL}, −2 mA I_{OH}
- TTL−compatible Inputs
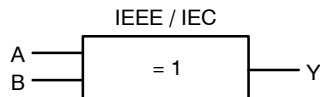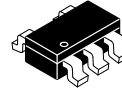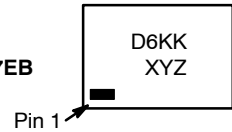- These Devices are Pb−Free, Halogen Free/BFR Free and are RoHS Compliant
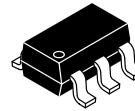

Figure 1. Logic Symbol

MARKING DIAGRAMS

SIP6 CASE 127EB	D6KK XYZ Pin 1
SC−74A CASE 318BQ	8S86M∎
SOT23−5 CASE 527AH	8S86 M
SC−88A CASE 419A−02	T86M∎
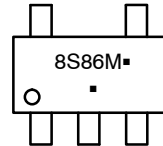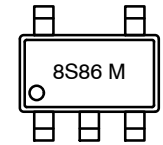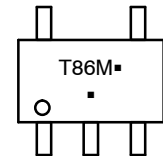
D6, 8S86, T86 = Specific Device Code
KK = 2−Digit Lot Run Traceability Code
XY = 2−Digit Date Code Format
Z = Assembly Plant Code
M = Date Code*

*Date Code orientation and/or position may vary depending upon manufacturing location.

ORDERING INFORMATION

NC7ST86

Pin Configurations
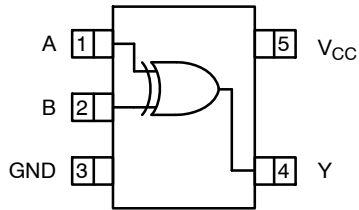
Figure 2. SOT23−5, SC−88A and SC−74A (Top View)
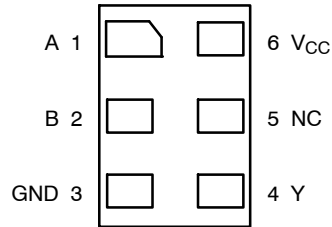
Figure 3. MicroPak (Top Through View)

PIN DESCRIPTIONS

Pin Name	Description
A, B	Input
Y	Output
NC	No Connect

FUNCTION TABLE ($Y = A \oplus B$)

Inputs		Output
A	**B**	**Y**
L	L	L
L	H	H
H	L	H
H	H	L

H = HIGH Logic Level
L = LOW Logic Level

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter		Min	Max	Unit
V_{CC}	Supply Voltage		−0.5	6.5	V
I_{IK}	DC Input Diode Current	$V_{IN} < 0$ V	–	−20	mA
		$V_{IN} > V_{CC}$	–	+20	
V_{IN}	DC Input Voltage		−0.5	$V_{CC} + 0.5$	V
I_{OK}	DC Output Diode Current	$V_{OUT} < 0$ V	–	−20	mA
		$V_{OUT} > V_{CC}$	–	+20	
V_{OUT}	Output Voltage		−0.5	$V_{CC} + 0.5$	V
I_{OUT}	DC Output Source or Sink Current		–	±12.5	mA
I_{CC} or I_{GND}	DC V_{CC} or Ground Current per Supply Pin		–	±25	mA
T_{STG}	Storage Temperature		−65	+150	°C
T_J	Junction Temperature		–	+150	°C
T_L	Lead Temperature (Soldering, 10 Seconds)		–	+260	°C
P_D	Power Dissipation in Still Air	SC−74A / SOT23−5	–	390	mW
		SC−88A	–	332	
		MicroPak−6	–	812	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

NC7ST86

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	Supply Voltage		4.5	5.5	V
V_{IN}	Input Voltage		0	V_{CC}	V
V_{OUT}	Output Voltage		0	V_{CC}	V
T_A	Operating Temperature		−40	+85	°C
t_r, t_f	Input Rise and Fall Time	V_{CC} = 5.0 V	0	10	ns/V
θ_{JA}	Thermal Resistance	SC−74A / SOT23−5	–	320	°C/W
		SC−88A	–	377	
		MicroPak−6	–	154	

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.
1. Unused inputs must be held HIGH or LOW. They may not float.

DC ELECTICAL CHARACTERISTICS

Symbol	Parameter	V_{CC} (V)	Conditions	T_A = +25°C			T_A = −40 to +85°C		Unit
				Min	Typ	Max	Min	Max	
V_{IH}	HIGH Level Input Voltage	4.5 – 5.5		2.0	–	–	2.0	–	V
V_{IL}	LOW Level Input Voltage	4.5 – 5.5		–	–	0.8	–	0.8	V
V_{OH}	HIGH Level Output Voltage	4.5	I_{OH} = −20 μA, V_{IN} = V_{IL},	4.4	4.5	–	4.4	–	V
		4.5	V_{IH} I_{OH} = −2 mA	4.18	4.35	–	4.13	–	
V_{OL}	LOW Level Output Voltage	4.5	I_{OL} = 20 μA, V_{IN} = V_{IL},	–	0	0.1	–	0.1	V
		4.5	V_{IH} I_{OL} = 2 mA	–	0.10	0.26	–	0.33	
I_{IN}	Input Leakage Current	5.5	0 ≤ V_{IN} ≤ 5.5 V	–	–	±0.1	–	±1.0	μA
I_{CC}	Quiescent Supply Current	5.5	V_{IN} = V_{CC} or GND	–	–	1.0	–	10.0	μA
I_{CCT}	I_{CC} per Input	5.5	One Input V_{IN} = 0.5 V or 2.4 V, Other Input V_{CC} or GND	–	–	2.0	–	2.9	mA

AC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	V_{CC} (V)	Conditions	T_A = +25°C			T_A = −40 to +85°C		Unit
				Min	Typ	Max	Min	Max	
t_{PLH}, t_{PHL}	Propagation Delay (Figure 4, 6)	5.0	C_L = 15 pF	–	4.4	14	–	–	ns
				–	7.4	19	–	–	
		4.5	C_L = 50 pF	–	6.6	18	–	22	
				–	13.1	29	–	33	
		5.5		–	5.6	16	–	20	
				–	12.5	28	–	32	
t_{TLH}, t_{THL}	Output Transition Time (Figure 4, 6)	5.0	C_L = 15 pF	–	4	10	–	–	ns
		4.5	C_L = 50 pF	–	11	25	–	31	
		5.5		–	10	21	–	26	
C_{IN}	Input Capacitance	Open		–	2	10	–	–	pF
C_{PD}	Power Dissipation Capacitance (Figure 5)	5.0	(Note 2)	–	8	–	–	–	pF

2. C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current. Current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. (See Figure 5) C_{PD} is related to I_{CCD} dynamic operating current by the expression: I_{CCD} = (C_{PD}) (V_{CC}) (f_{IN}) + (I_{CC}static).
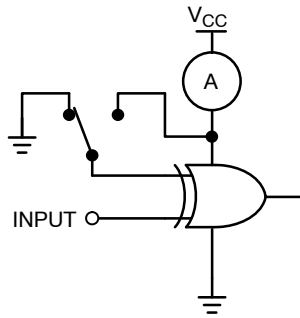
AC Loading and Waveforms
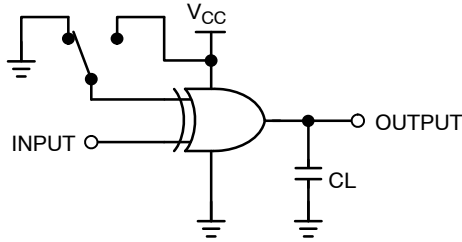
C_L includes load and stray capacitance
Input PRR = 1.0 MHz; t_W = 500 ns

Figure 4. AC Test Circuit

Input = AC Waveforms;
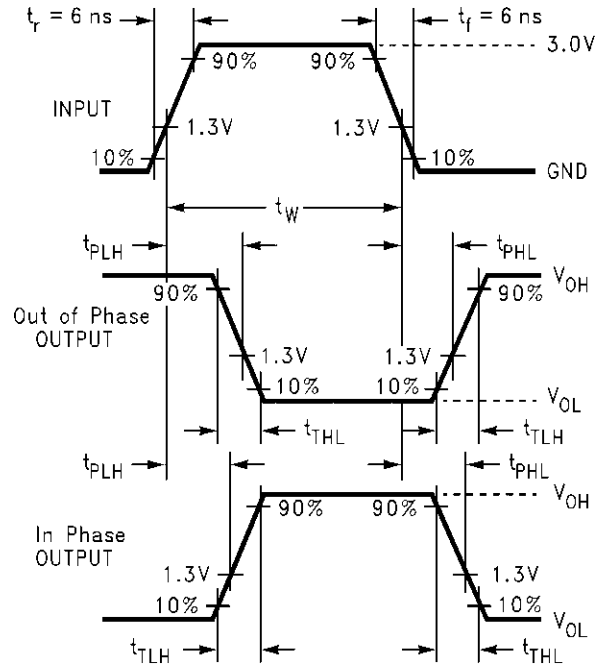PRR = Variable; Duty Cycle = 50%.

Figure 5. I_{CCD} Test Circuit

Figure 6. AC Waveforms

ORDERING INFORMATION

Order Number	Top Mark	Package Description	Shipping[†]
NC7ST86M5X	8S86	SC−74A	3000 / Tape & Reel
NC7ST86M5X−L22090	8S86	SOT23−5	3000 / Tape & Reel
NC7ST86P5X	T86	SC−88A	3000 / Tape & Reel
NC7ST86P5X−L22057	T86	SC−88A	3000 / Tape & Reel
NC7ST86L6X	D6	SIP6, MicroPak	5000 / Tape & Reel
NC7ST86L6X−L22175	D6	SIP6, MicroPak	5000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

SIP6 1.45X1.0
CASE 127EB
ISSUE O

DATE 31 AUG 2016

TOP VIEW

PIN 1 IDENTIFIER

RECOMMENED
LAND PATTERN

DETAIL A

BOTTOM VIEW

DETAIL A
PIN 1 TERMINAL

0.075 X 45° CHAMFER
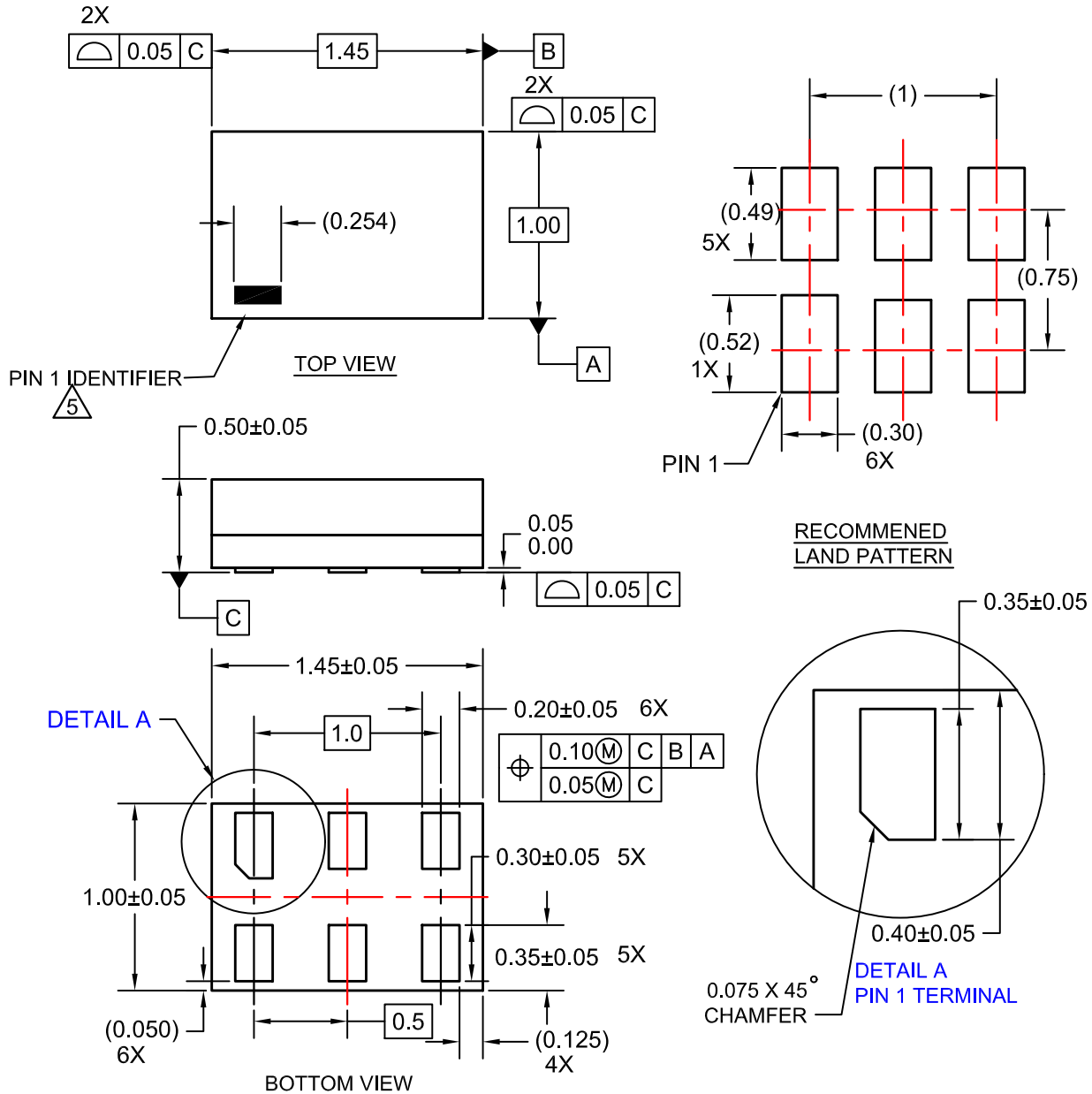
NOTES:

1. CONFORMS TO JEDEC STANDARD MO-252 VARIATION UAAD
2. DIMENSIONS ARE IN MILLIMETERS
3. DRAWING CONFORMS TO ASME Y14.5M-2009
4. PIN ONE IDENTIFIER IS 2X LENGTH OF ANY
   OTHER LINE IN THE MARK CODE LAYOUT.

DOCUMENT NUMBER:	98AON13590G		
DESCRIPTION:	SIP6 1.45X1.0		PAGE 1 OF 1

onsemi

SC−88A (SC−70−5/SOT−353)
CASE 419A−02
ISSUE M

DATE 11 APR 2023
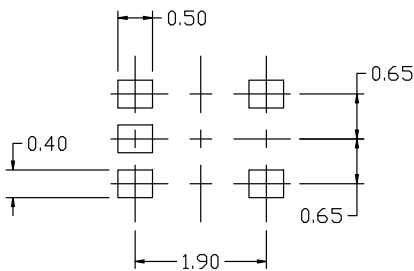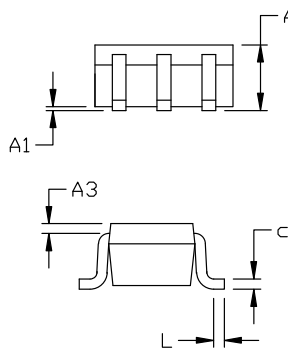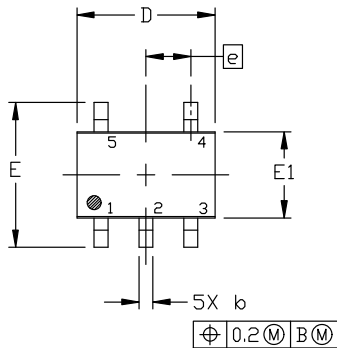
SCALE 2:1

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

2. CONTROLLING DIMENSION: MILLIMETERS

3. 419A−01 OBSOLETE. NEW STANDARD 419A−02

4. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.1016MM PER SIDE.

DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.80	0.95	1.10
A1	---	---	0.10
A3	0.20 REF		
b	0.10	0.20	0.30
c	0.10	---	0.25
D	1.80	2.00	2.20
E	2.00	2.10	2.20
E1	1.15	1.25	1.35
e	0.65 BSC		
L	0.10	0.15	0.30
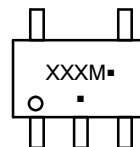
⊕ 0.2 Ⓜ B Ⓜ

5X b

RECOMMENDED MOUNTING FOOTPRINT

0.50
0.65
0.40
0.65
1.90

* For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM*

XXXM∎

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, "G" or microdot "∎", may or may not be present. Some products may not follow the Generic Marking.

XXX = Specific Device Code
M = Date Code
∎ = Pb−Free Package

(Note: Microdot may be in either location)

STYLE 1:
PIN 1. BASE
2. EMITTER
3. BASE
4. COLLECTOR
5. COLLECTOR

STYLE 2:
PIN 1. ANODE
2. EMITTER
3. BASE
4. COLLECTOR
5. CATHODE

STYLE 3:
PIN 1. ANODE 1
2. N/C
3. ANODE 2
4. CATHODE 2
5. CATHODE 1

STYLE 4:
PIN 1. SOURCE 1
2. DRAIN 1/2
3. SOURCE 1
4. GATE 1
5. GATE 2

STYLE 5:
PIN 1. CATHODE
2. COMMON ANODE
3. CATHODE 2
4. CATHODE 3
5. CATHODE 4

STYLE 6:
PIN 1. EMITTER 2
2. BASE 2
3. EMITTER 1
4. COLLECTOR
5. COLLECTOR 2/BASE 1

STYLE 7:
PIN 1. BASE
2. EMITTER
3. BASE
4. COLLECTOR
5. COLLECTOR

STYLE 8:
PIN 1. CATHODE
2. COLLECTOR
3. N/C
4. BASE
5. EMITTER

STYLE 9:
PIN 1. ANODE
2. CATHODE
3. ANODE
4. ANODE
5. ANODE

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

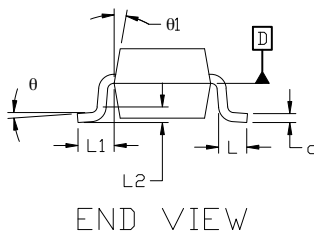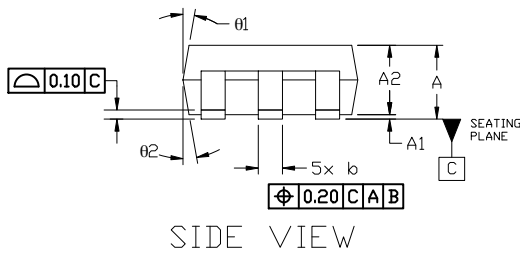| DOCUMENT NUMBER:	98ASB42984B	
DESCRIPTION:	SC−88A (SC−70−5/SOT−353)	PAGE 1 OF 1

ON Semiconductor®

SOT−23, 5 Lead
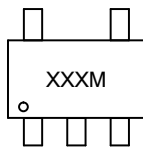CASE 527AH
ISSUE A

DATE 09 JUN 2021
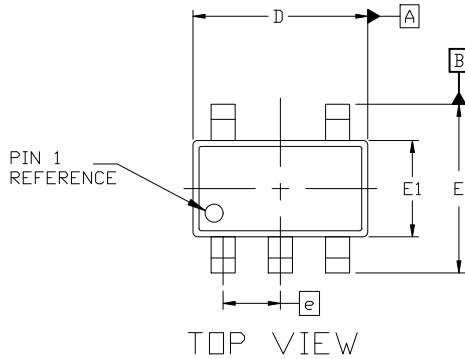
NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 19894
2. CONTROLLING DIMENSION: MILLIMETERS
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL.
4. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.25 PER SIDE. D AND E1 DIMENSIONS ARE DETERMINED AT DATUM D.
5. DIMENSION 'b' DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08mm TOTAL IN EXCESS OF THE 'b' DIMENSION AT MAXIMUM MATERIAL CONDITION. MINIMUM SPACE BETWEEN PROTRUSION AND AN ADJACENT LEAD SHALL NOT BE LESS THAN 0.07mm.

PIN 1 REFERENCE

TOP VIEW

SIDE VIEW

END VIEW

DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.90	—	1.45
A1	0.00	—	0.15
A2	0.90	1.15	1.30
b	0.30	—	0.50
c	0.08	—	0.22
D	2.90 BSC		
E	2.80 BSC		
E1	1.60 BSC		
e	0.95 BSC		
L	0.30	0.45	0.60
L1	0.60 REF		
L2	0.25 REF		
θ	0°	4°	8°
θ1	0°	10°	15°
θ2	0°	10°	15°
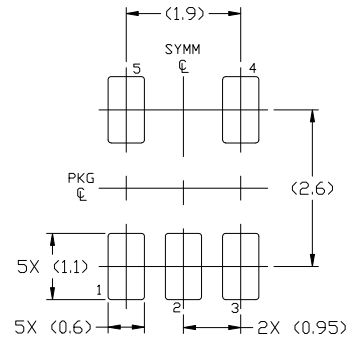
GENERIC MARKING DIAGRAM*

XXXM

XXX = Specific Device Code
M = Date Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DOCUMENT NUMBER:	98AON34320E	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.	
DESCRIPTION:	SOT−23, 5 LEAD		PAGE 1 OF 1

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:
Technical Library: www.onsemi.com/design/resources/technical–documentation
onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support
For additional information, please contact your local Sales Representative at
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